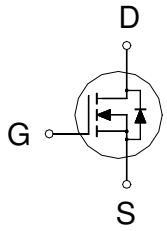
杰力科技股份有限公司
Excelliance MOS Corporation

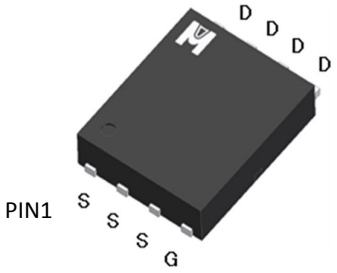
EMB07N03HR

N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	30V
$R_{DSON\ (MAX.)}$	7mΩ
I_D	50A





N Channel MOSFET

UIS, Rg 100% Tested

Pb-Free Lead Plating & Halogen Free

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T_C = 25 °C	I_D	50	A
	T_C = 100 °C		35	
Pulsed Drain Current[1]		I_{DM}	140	
Avalanche Current		I_{AS}	37.5	
Avalanche Energy	L = 0.1mH, I_{AS}=37.5A, RG=25Ω	E_{AS}	70	mJ
Repetitive Avalanche Energy[2]	L = 0.05mH	E_{AR}	15	
Power Dissipation	T_C = 25 °C	P_D	50	W
	T_C = 100 °C		20	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	°C

100% UIS testing in condition of V_D=15V, L=0.1mH, V_G=10V, I_L=25A, Rated V_{DS}=25V N-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		2.5	°C / W
Junction-to-Ambient[3]	$R_{\theta JA}$		50	

[1]Pulse width limited by maximum junction temperature.

[2]Duty cycle ≤ 1%

[3]50°C / W when mounted on a 1 in^2 pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250µA	30			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250µA	1.0	1.7	3.0	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 24V, V_{GS} = 0V			1	µA
		V_{DS} = 20V, V_{GS} = 0V, T_J = 125 °C			25	
On-State Drain Current[1]	$I_{D(ON)}$	V_{DS} = 10V, V_{GS} = 10V	50			A
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 25A		5.5	7	mΩ
		V_{GS} = 4.5V, I_D = 20A		6.5	9	
Forward Transconductance[1]	g_{fs}	V_{DS} = 5V, I_D = 20A		18		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 15V, f = 1MHz		1014		pF
Output Capacitance	C_{oss}			163		
Reverse Transfer Capacitance	C_{rss}			93		
Gate Resistance	R_g	V_{GS} = 15mV, V_{DS} = 0V, f = 1MHz		2.2		Ω
Total Gate Charge[1,2]	Q_g(V_{GS}=10V)	V_{DS} = 15V, V_{GS} = 10V, I_D = 25A		15		nC
	Q_g(V_{GS}=4.5V)			8.5		
Gate-Source Charge[1,2]	Q_{gs}			3.3		
Gate-Drain Charge[1,2]	Q_{gd}			3.5		
Turn-On Delay Time[1,2]	$t_{d(on)}$	V_{DS} = 15V, I_D = 20A, V_{GS} = 10V, R_{GS} = 2.7Ω		10		nS
Rise Time[1,2]	t_r			10		
Turn-Off Delay Time[1,2]	$t_{d(off)}$			20		
Fall Time[1,2]	t_f			15		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)						
Continuous Current	I_S				50	A
Pulsed Current[3]	I_{SM}				140	
Forward Voltage[1]	V_{SD}	I_F = I_S, V_{GS} = 0V			1.3	V
Reverse Recovery Time	t_{rr}	I_F = I_S, dI_F/dt = 100A / µS		20		nS
Peak Reverse Recovery Current	$I_{RM(REC)}$			180		A
Reverse Recovery Charge	Q_{rr}			11		nC

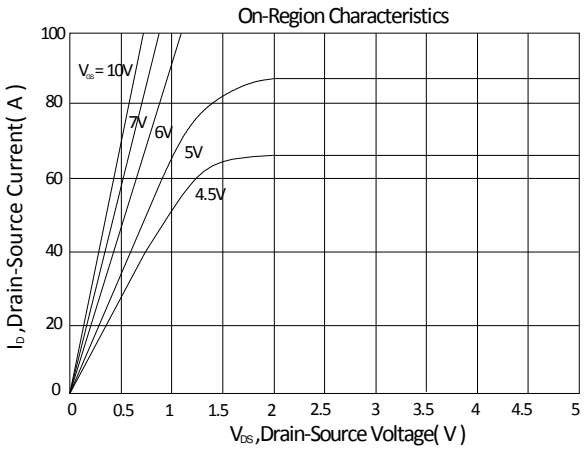
[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

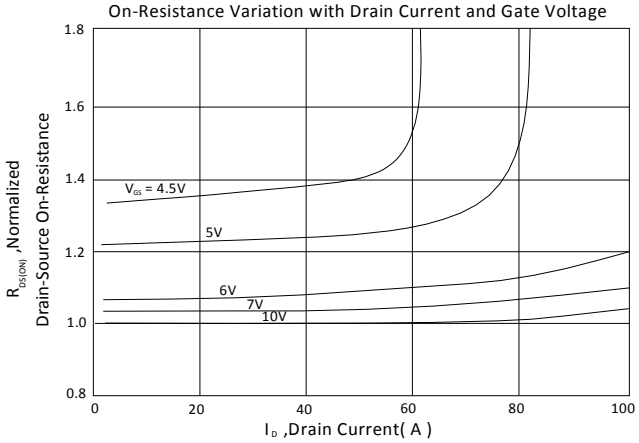
[2]Independent of operating temperature.

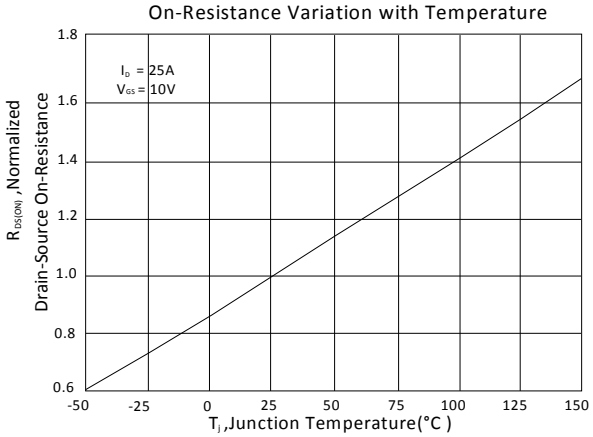
[3]Pulse width limited by maximum junction temperature.

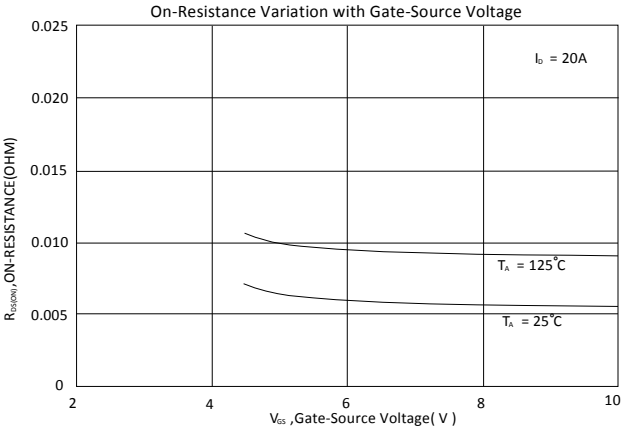
EMC will review datasheet by quarter, and update new version.

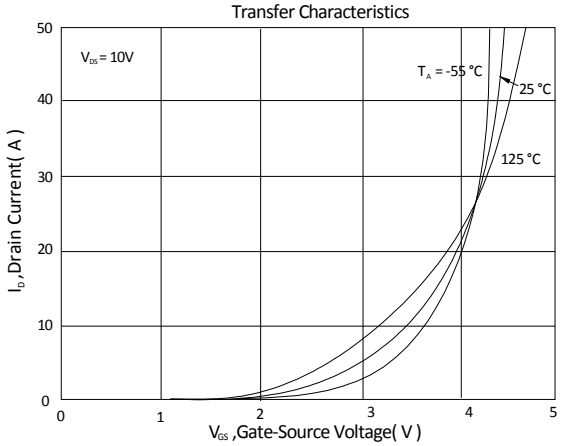
TYPICAL CHARACTERISTICS

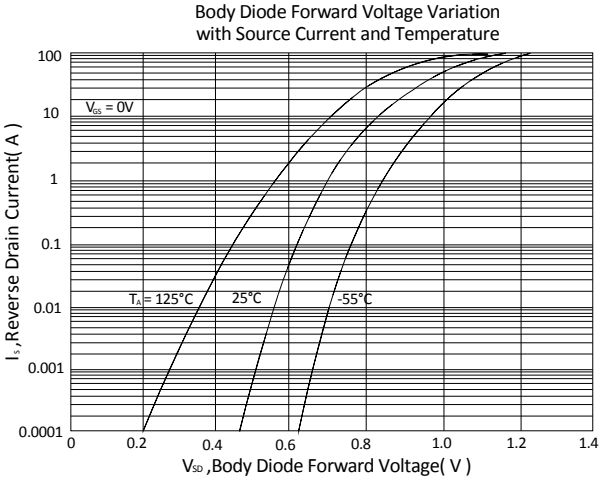


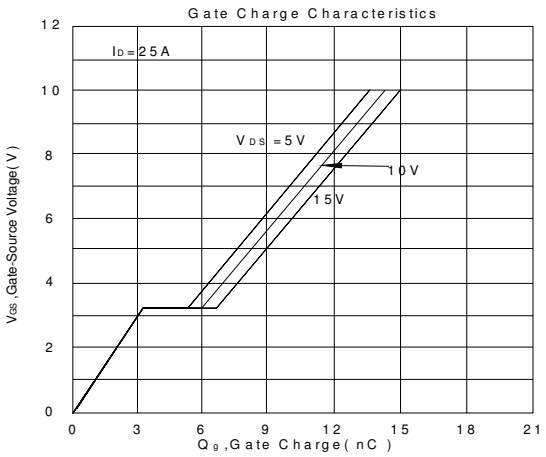


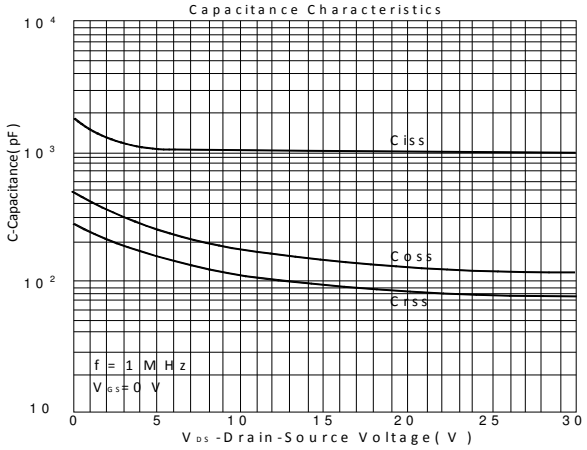


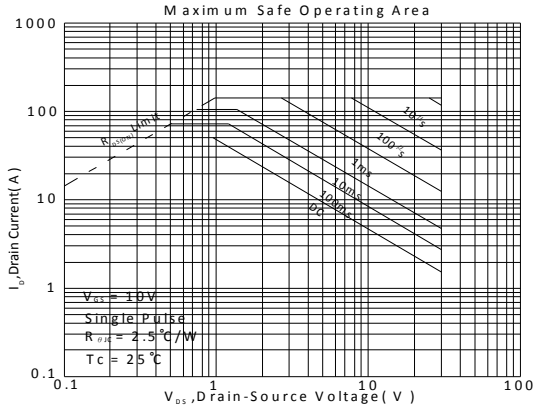


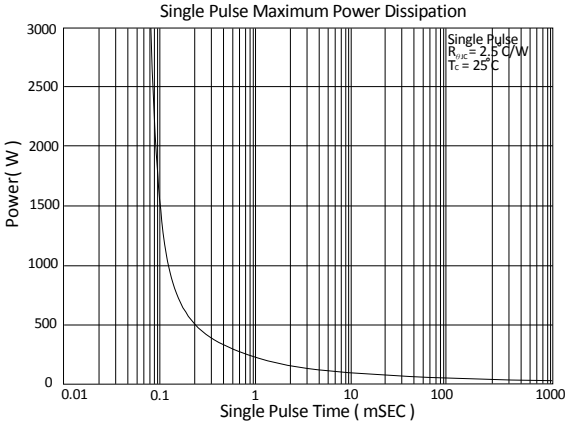


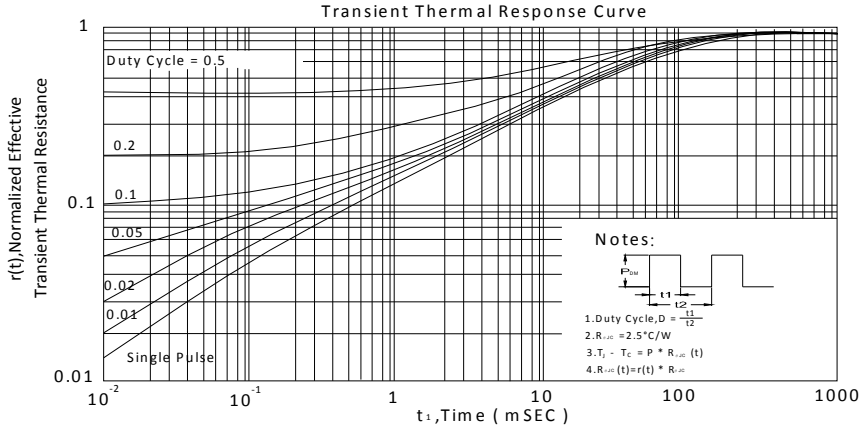



Gate Charge Characteristics
ID=25A
VDS=5V
10V
15V
VGS,Gate-Source Voltage(V)
Qg,Gate Charge(nC)


Capacitance Characteristics
Ciss
Coss
Crss
f=1MHz
VGS=0V
C-Capacitance(pF)
VDS-Drain-Source Voltage(V)

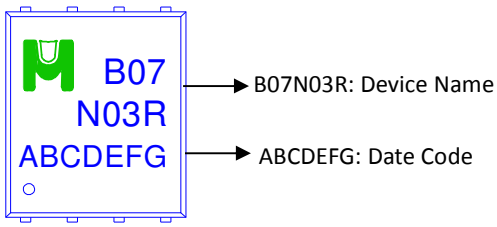

Maximum Safe Operating Area
VGS=10V
Single Pulse
RθJC=2.5°C/W
Tc=25°C
ID,Drain Current(A)
VDS,Drain-Source Voltage(V)


Single Pulse Maximum Power Dissipation
Single Pulse
RθJC=2.5°C/W
Tc=25°C
Power(W)
Single Pulse Time(mSEC)

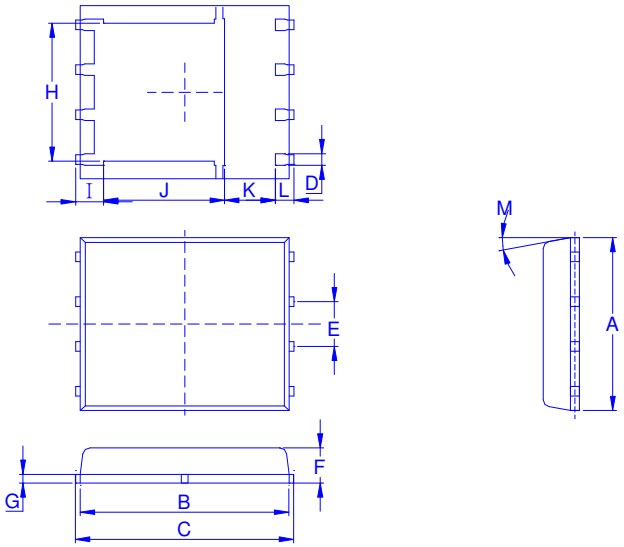

Transient Thermal Response Curve
Duty Cycle=0.5
0.2
0.1
0.05
0.02
0.01
Single Pulse
Notes:
1.Duty Cycle,D=t1/t2
2.RθJC=2.5°C/W
3.TJ-TC=P*RθJC(t)
4.RθJC(t)=r(t)*RθJC
r(t),Normalized Effective Transient Thermal Resistance
t1,Time(mSEC)

Ordering & Marking Information:

Device Name: EMB07N03HR for EDFN5X6



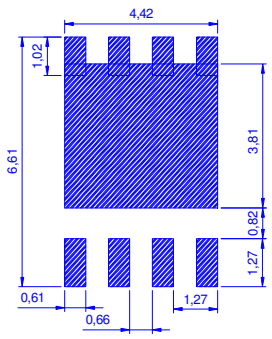
Outline Drawing



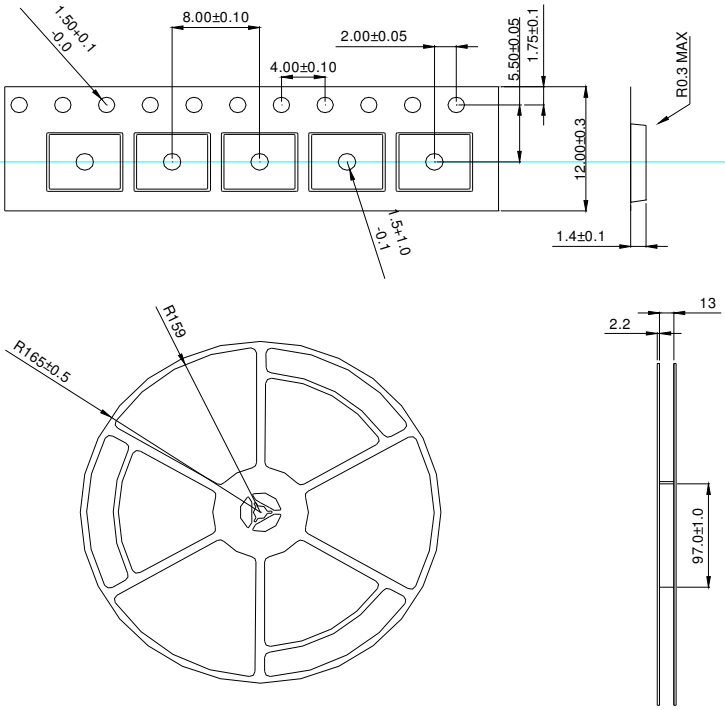
Dimension in mm

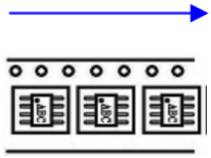
Dimension	A	B	C	D	E	F	G	H	I	J	K	L	M
Min	4.80	5.55	5.90	0.30	1.17	0.85	0.15	3.61	0.38	3.18	1.00	0.38	0 °
Typ.	4.90	5.70	6.00	0.40	1.27	0.95	0.20	3.87	0.40	3.44	1.20	0.40	
Max	5.40	5.85	6.15	0.51	1.37	1.17	0.34	4.31	0.71	3.78	1.39	0.71	12 °

Recommended minimum pads



◆ Tape&Reel Information:2500pcs/Reel(Dimension in millimeter)



產品別	EDFN5X6
Reel 尺寸	13”
編帶方式	FEED DIRECTION 
前空格	25
後空格	50
裝箱數	
滿捲數量	2.5K
捲/內盒比	1：1
內盒滿箱數	2.5K
內/外箱比	10：1
外箱滿箱數	25K